

3.2X1.6mm SMD CHIP LED LAMP

KPC-3216SEC

SUPER BRIGHT ORANGE

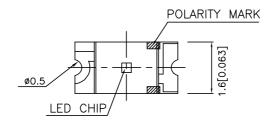
Features

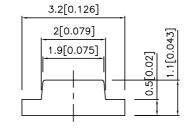
- •3.2X1.6mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS / REEL .

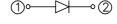
Description

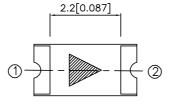
The Super Bright Orange device is made with DH InGaAIP (on GaAs substrate) light emitting diode chip.

Package Dimensions









Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.0079\mbox{"})$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Dice Lens Type Iv (mcd) @ 20mA		Viewing Angle	
		-	Min.	Тур.	2 θ 1/2
KPC-3216SEC	SUPER BRIGHT ORANGE (InGaAIP)	WATER CLEAR	70	200	120°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Orange	610		nm	IF=20mA
λD	Dominant Wavelength	Super Bright Orange	601		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Orange	29		nm	IF=20mA
С	Capacitance	Super Bright Orange	30		pF	VF=0V;f=1MHz
VF	Forward Voltage	Super Bright Orange	2.0	2.5	V	IF=20mA
IR	Reverse Current	Super Bright Orange		10	uA	VR= 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Super Bright Orange	
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	195	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

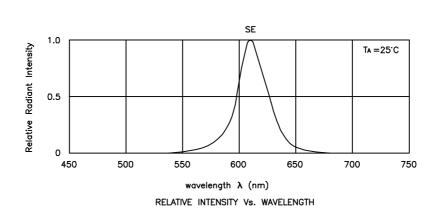
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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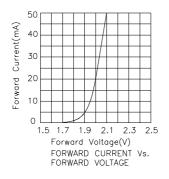
 $^{1. \}theta^{1/2}$ is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

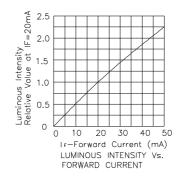
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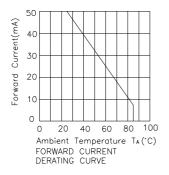


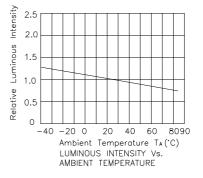
Super Bright Orange

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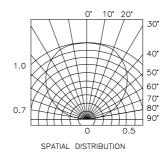








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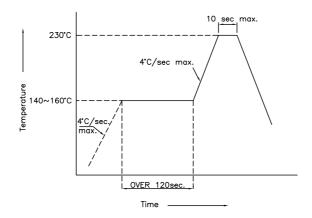
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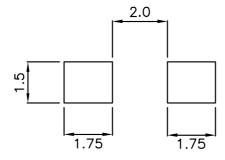
KPC-3216SEC SMT Reflow Soldering Instructions

Number of reflow process shall be 2 times or less and cooling process to normal temperature is required between first and second soldering process.

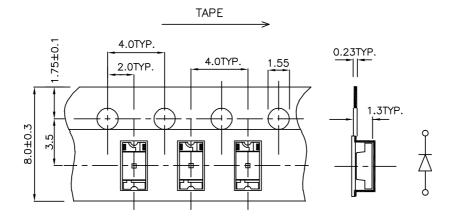


Recommended Soldering Pattern

(Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage,luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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